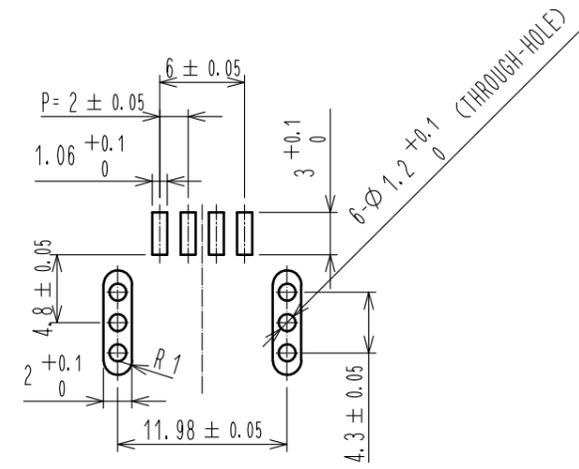
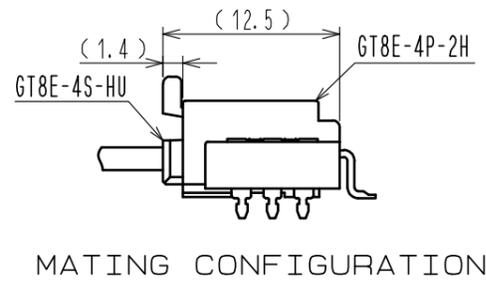
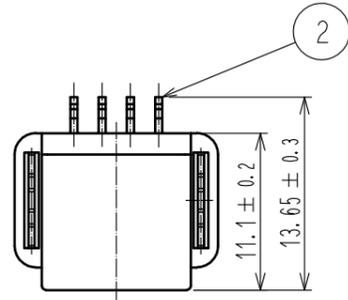
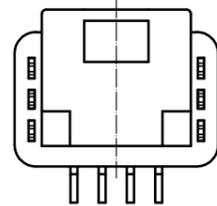
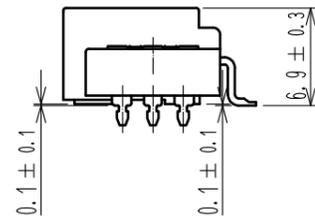
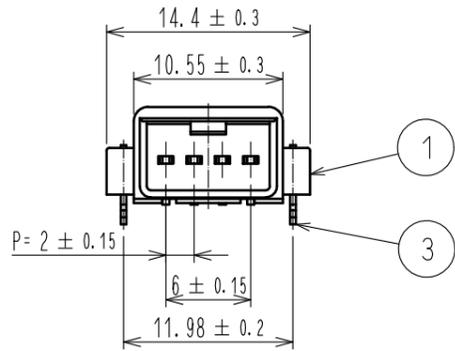
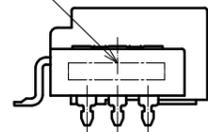


ELV. RoHS COMPLIANT

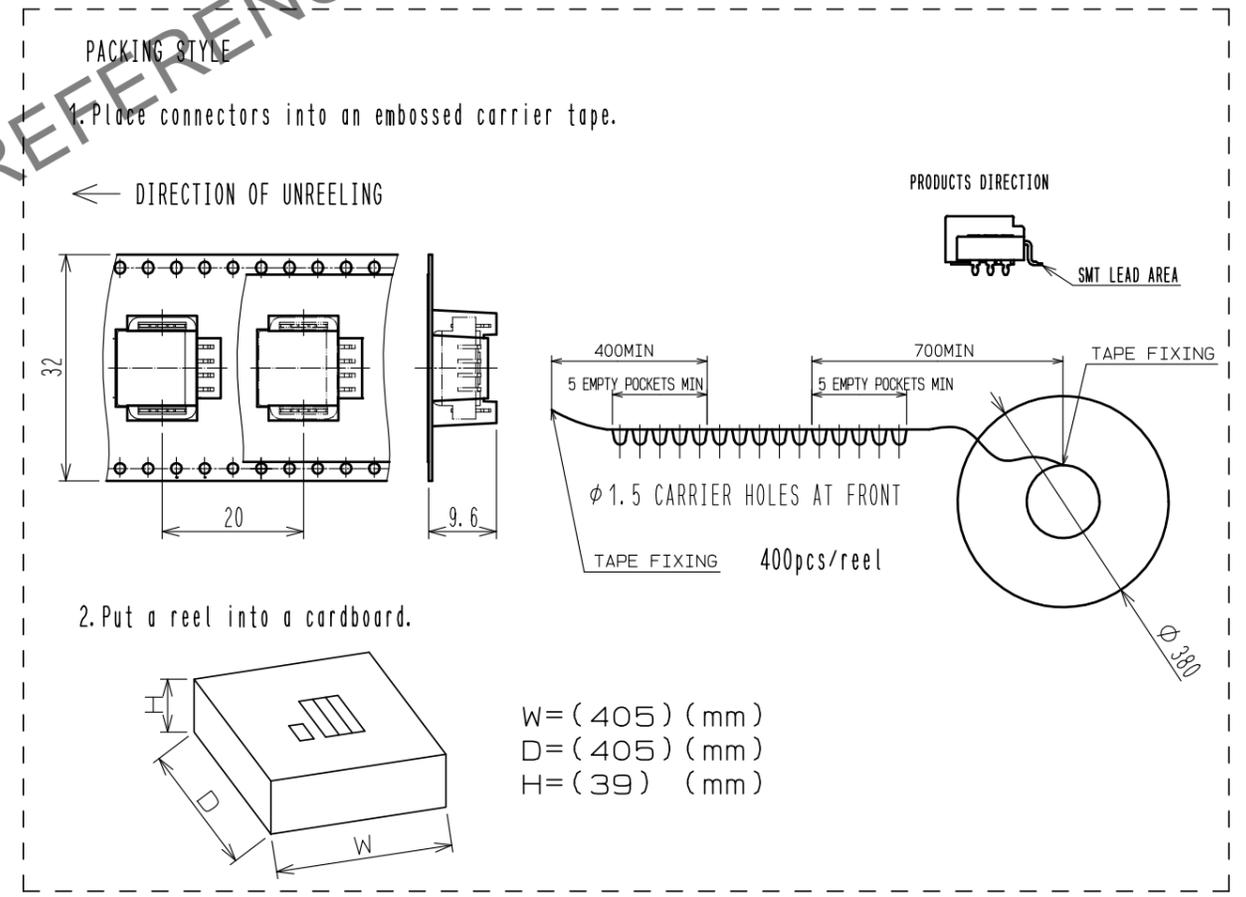


RECOMMENDED PC BOARD PATTERN

4 LOT No



HRS DRAWING FOR REFERENCE

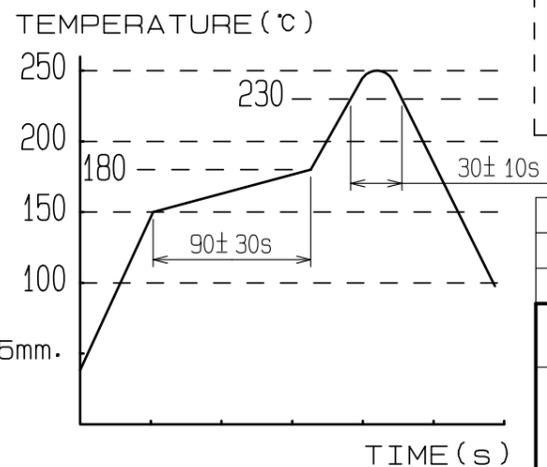


NOTE 1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW (REFER TO RIGHT FIG.)
REFLOW HEATING METHODS: FAR-INFRARED, IN THE AIR OR NITROGEN

REFLOW No.: MAX 2TIMES
PEAK TEMPERATURE: 250°C
ABOVE 230°C: 20~40s
PREHEAT: 150~180°C
60~120s

2. SOLDERING TEMPERATURE: 280~300°C, MAX 2s
3. COPLANARITY OF LEADS SHALL BE UNDER 0.1mm.

4. MARKING OF LOT No.:
(EX) 2008. 2ND. JULY → 08G02...5DIGITS
5. RECOMMENDED THICKNESS FOR PC BOARD IS 1.6mm.
6. RECOMMENDED THICKNESS FOR SOLDER PASTE IS 0.15mm.



2	BRASS	TIN PLATING			
1	PPS	BLACK	3	BRASS	TIN PLATING
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED
HRS HIROSE ELECTRIC CO., LTD.		APPROVED : HK. UMEHARA	20201019	DRAWING NO.	EDC-167409-55-00
		CHECKED : HH. TSUKUMO	20201019	PART NO.	GT8E-4P-2H(55)
		DESIGNED : DONGCHAN KIM	20201019	CODE NO.	CL758-0079-5-55
		DRAWN : AN. SAIKI	20201016		1/1

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